

MOSFET

OptiMOS[™] 5 Power-Transistor, 60 V

Features

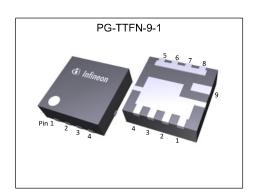
- Optimized for synchronous rectification
- 100% avalanche testedSuperior thermal resistance
- N-channel, normal level
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

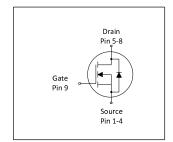
Product validation

Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

Parameter	Value	Unit
$V_{ extsf{DS}}$	60	V
R _{DS(on),max}	3.0	mΩ
I _D	137	A
Q _{oss}	42	nC
Q _G (0V10V)	39	nC











Type / Ordering Code	Package	Marking	Related Links
IQE030N06NM5CG	PG-TTFN-9-1	03006C5	-

OptiMOSTM 5 Power-Transistor, 60 V



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OptiMOS[™] 5 Power-Transistor, 60 V IQE030N06NM5CG



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	- - -	137 97 21	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =10V, T _A =25°C, R _{thJA} =60°C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	547	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	153	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	107 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Davameter	Symbol	Values			llnit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	_	-	1.4	°C/W	-
Device on PCB, 6 cm² cooling area ²⁾	R _{thJA}	_	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Davamatav	0		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=50\ \mu{\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.5 10	1.0 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.2 3.3	3.0 5.0	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =6 V, I _D =5 A
Gate resistance	R _G	-	0.9	-	Ω	-
Transconductance	g_{fs}	-	120	-	S	

 Table 5
 Dynamic characteristics

Parameter	Symbol		Values			Note / Test Condition	
Farameter	Symbol		Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	2900	3800	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	600	780	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	37	65	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	10	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω	
Rise time	t _r	-	5.7	-	ns	V_{DD} =30 V, V_{GS} =10 V, I_{D} =20 A, $R_{\text{G,ext}}$ =3 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	18.8	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω	
Fall time	t _f	_	5.7	-	ns	V_{DD} =30 V, V_{GS} =10 V, I_{D} =20 A, $R_{G,ext}$ =3 Ω	

Gate charge characteristics²⁾ Table 6

Parameter	Sumb al	Values			11-14	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	12.2	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	8.1	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	6.8	10.2	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	10.9	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	39	49	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	4.2	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	35	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	42	56	nC	V _{DS} =30 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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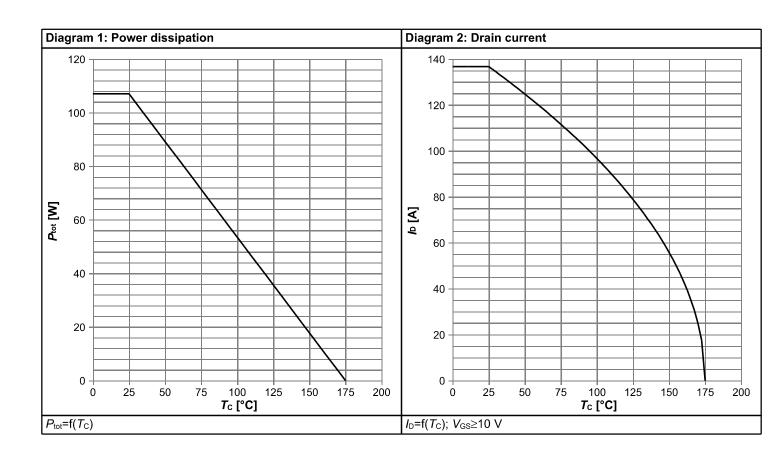


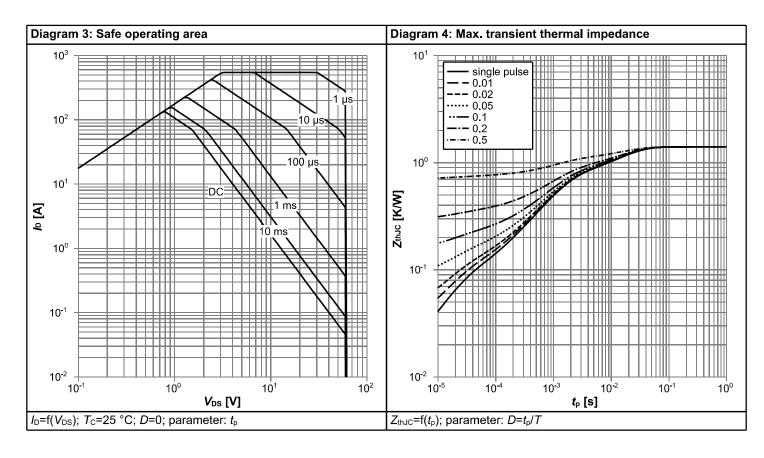
Table 7 Reverse diode

D	Cymah al		Values			Note / Total Constitution
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	72	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	547	Α	T _C =25 °C
Diode forward voltage	V_{SD}	-	0.82	1.2	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	31	62	ns	V _R =30 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	26	52	nC	V _R =30 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

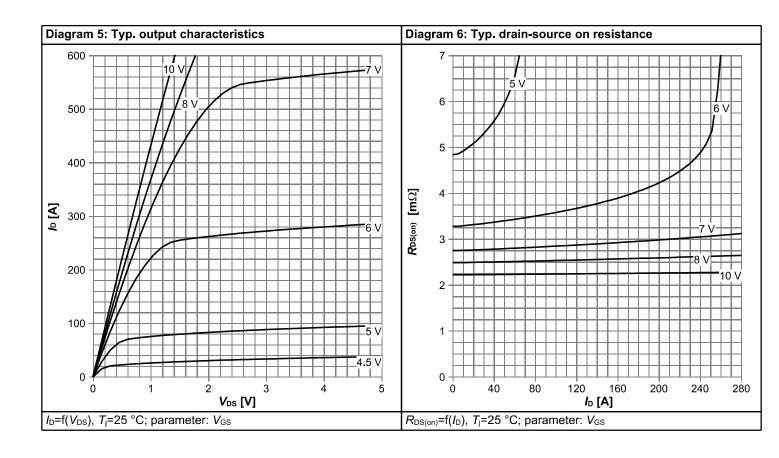


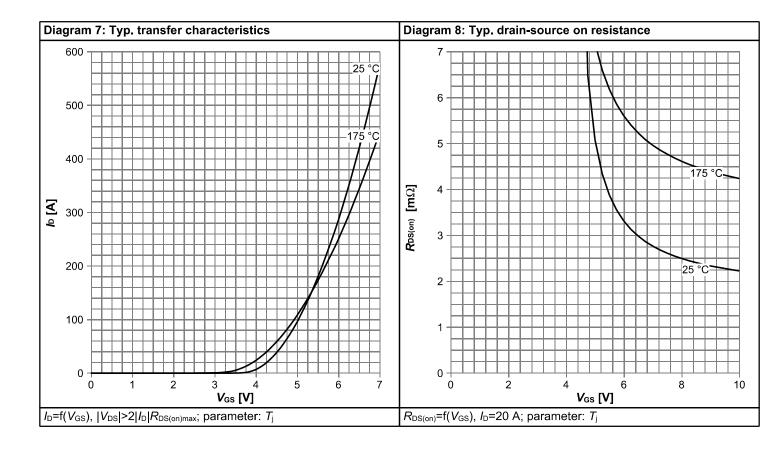
4 Electrical characteristics diagrams



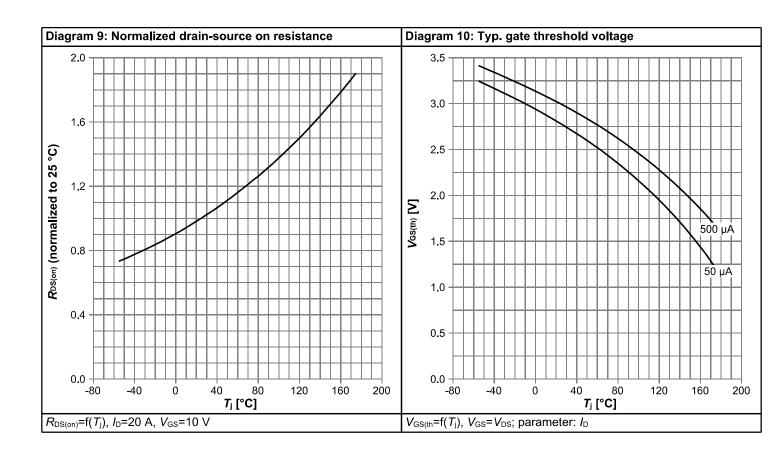


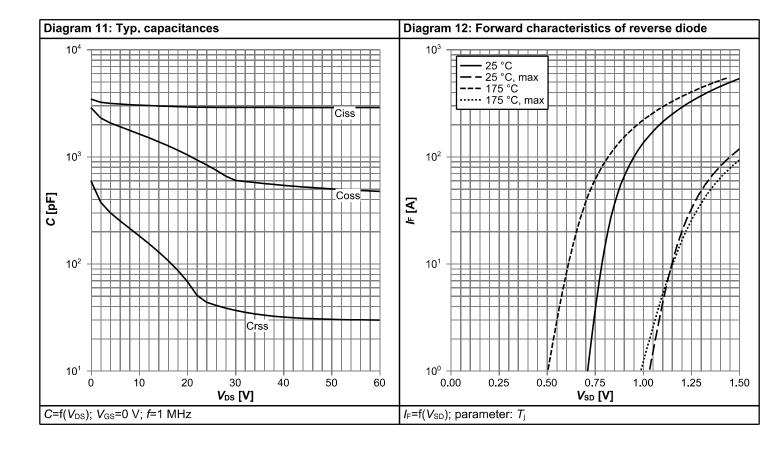




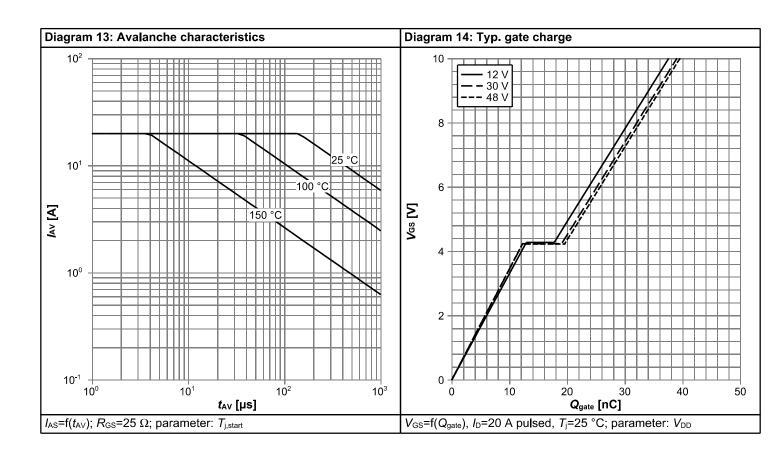


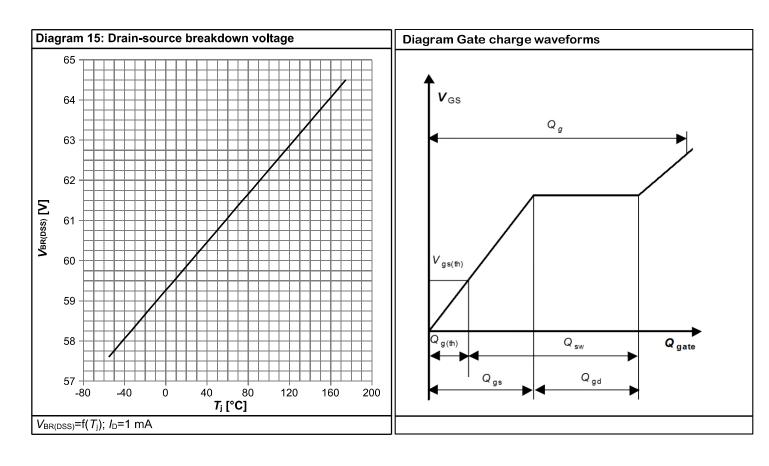






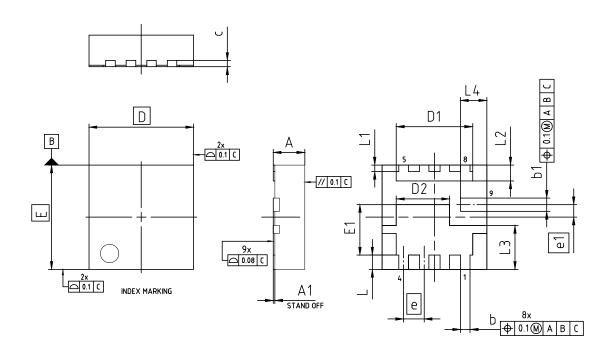








5 Package Outlines



DIMENSION	MILLIMETERS					
DIMENSION	MIN.	MAX.				
Α	-	1.10				
A1	-	0.05				
b	0.20	0.40				
b1	0.32	0.52				
С	0.	20				
D	3.	30				
D1	2.31	2.51				
D2	1.58	1.78				
E	3.30					
E1	1.50	1.70				
е	0.65					
e1	0.3	395				
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.285	1.485				
L4	0.73	0.93				

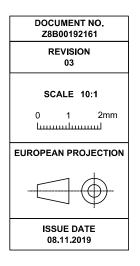


Figure 1 Outline PG-TTFN-9-1, dimensions in mm



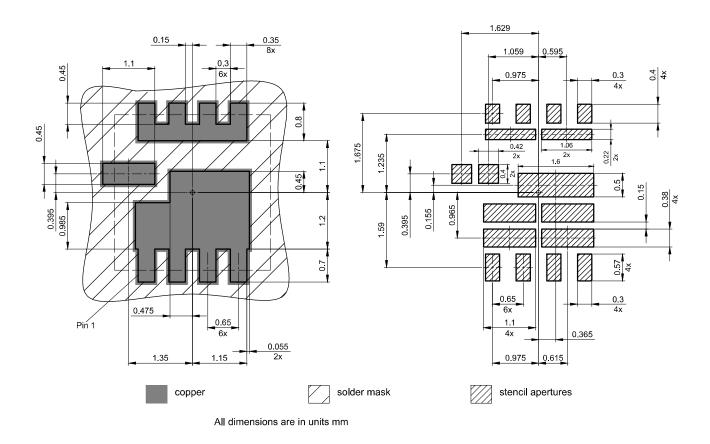


Figure 2 Outline Boardpad (PG-TTFN-9-1), dimensions in mm

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Revision History

IQE030N06NM5CG

Revision: 2021-04-27, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-04-27	Release of final version

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